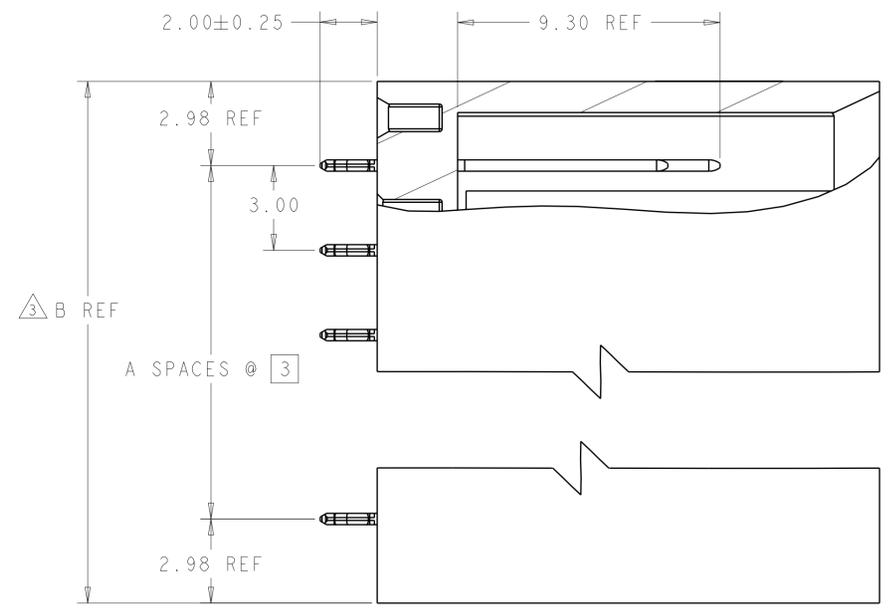
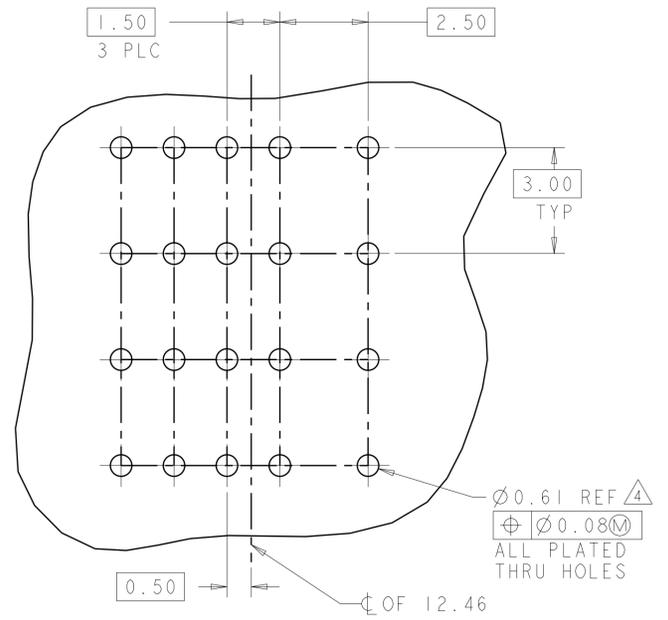
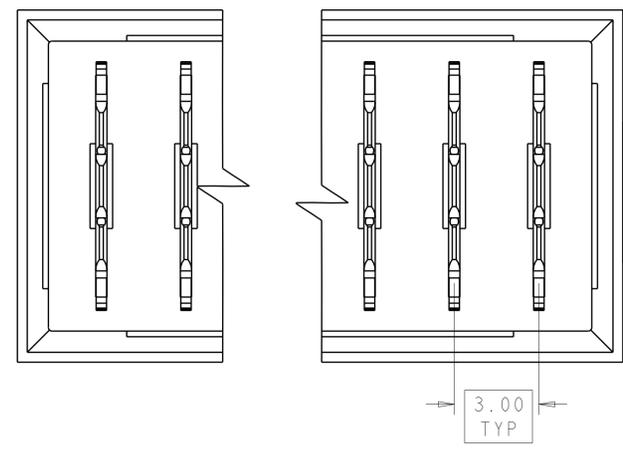
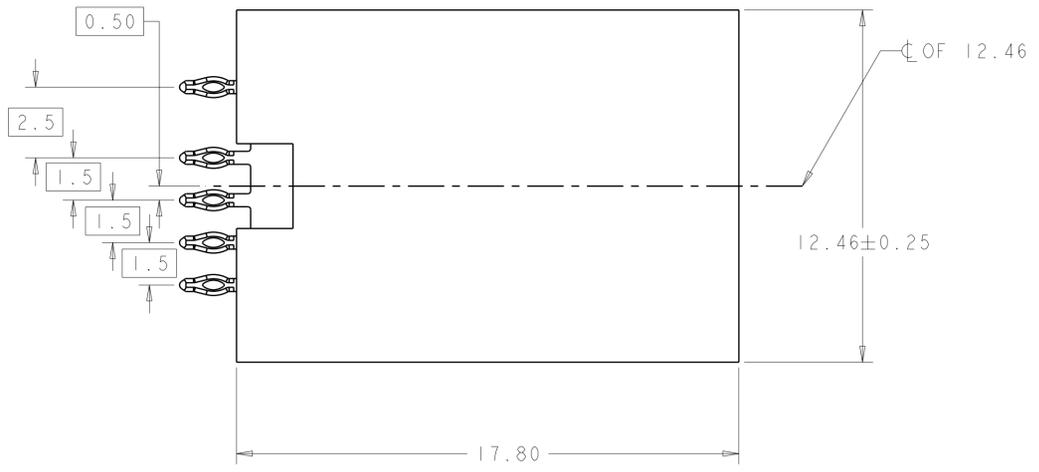


LOC	DIST	REV	DATE	BY	APPD
AD	00				

REV	DESCRIPTION	DATE	BY	APPD
2	REVISED NAME	14APR2009	DH	GG
3	REVISED	22JUL2009	DH	DY
A	RELEASED PER ECO-10-015209	23JUL2010	DH	DY

- 1 MATERIAL: HOUSING: POLYESTER, COLOR, GRAY, UL 94V-0.
CONTACT: HIGH CURRENT COPPER ALLOY.
- 2 FINISH: CONTACT MATING AREA: 1.27um MINIMUM GOLD
OR 0.8um MIN GOLD OVER 0.76um MIN PALLADIUM-NICKEL.
ACTION PIN AREA, 0.5um MINIMUM TIN PLATE,
ALL OVER 1.27um MINIMUM NICKEL UNDERPLATE.
- 3 TOLERANCE TO BE ±0.25 BEFORE CONNECTOR IS APPLIED TO PC BOARD.
- 4 REFERENCE APPLICATION SPEC 114-1103 FOR
RECOMENDED PLATED THRU HOLE DIAMETER AND
PLATING THICKNESS.
- 5. CURRENT RATING 16A/CONTACT PER PRODUCT SPEC 108-1651.



POSITION	B REF	A	PART NUMBER
9	29.95	8	1645499-7
8	26.95	7	1645499-6
7	23.95	6	1645499-5
6	20.95	5	1645499-4
5	17.95	4	1645499-3
4	14.95	3	1645499-2
3	11.95	2	1645499-1

RECOMMENDED PCB HOLE LAYOUT
SCALE 10:1

SECTION B-B

DIMENSIONS: mm 		TOLERANCES UNLESS OTHERWISE SPECIFIED: 9 PLC ± 1 PLC ± 2 PLC ±0.13 3 PLC ± 4 PLC ± ANGLES ±		DWN: D. HUMBERT 02MAR2009 CHK: G. GRIFFITH 02MAR2009 APPD: G. GRIFFITH 02MAR2009		Tyco Electronics Harrisburg, PA 17105-3608	
MATERIAL:		FINISH:		NAME: HEADER ASSEMBLY, VERTICAL UP, 18MM STACK HEIGHT		SIZE: A 00779 C=1645499	
CUSTOMER DRAWING				SCALE: 8:1		SHEET 1 OF 1 REV A	